



Ebisol 6

Base/Insulation board

Usage

For underfloor heating under wood, laminate, and vinyl floors
For dry areas
Suitable for both timber/gypsum board and concrete substrates

 (R) 0,18 m²K/W  (λ) 0.034 W/mK  6 mm

- ✓ Replaces traditional floor foam
- ✓ Energy-efficient installation
- ✓ Step sound attenuation

Ebisol is one of the most effective insulation materials on the market, designed for use under wood, laminate, and vinyl floors. The extruded polystyrene board has very high insulating capacity. Ebisol is flexible and can be installed on chipboard/gypsum board or concrete floors, is easy to cut and adapt to the surface, and is unaffected by moisture or water.

Specifications

Autoignition temperature	> +380 °C
Contains SVHC substances according to REACH	No
Continuous temperature, max.	70 °C
Compressive strength (EN 13164)	400 kPa
Solubility	High resistance to acids and bases. Soluble in organic solvent
Material	Extruded polystyrene
Melting point	100 °C
Thermal conductivity, λ	0.034 W/mK

Warranty

The general terms of delivery are listed below.
Our warranty terms

Article list

Article number	Quantity in packaging	Dimensions W x H x D (mm)	Area (m²)	Heat resistance, R (m²K/W)
8960176	10	600 x 1200 x 6	7.2	0.18

Learn more about this product: <https://www.ebeco.com/en/products/insulation/ebisol-6>